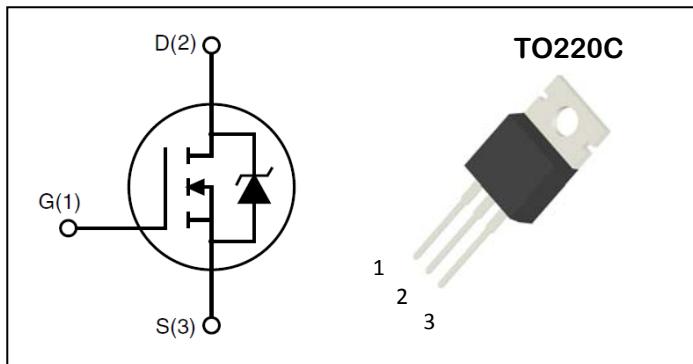


**N-Channel Enhancement Mode Field Effect Transistor****PRODUCT SUMMARY**

$V_{DSS}$	$I_D$	$R_{DS(ON)}$ ( $m\Omega$ )
40V	380A	1.5m $\Omega$

**Features:**

- Low Gate Charge for Fast Switching Application
- Low  $R_{DS(ON)}$  to Minimize Conductive Loss
- 100% EAS Guaranteed
- Fast Recovery Body Diode
- Lead-Free, RoHS Compliant

**Description:**

The ADM380N04 series MOSFETs is a new technology, which combines an innovative super junction technology and advance process. This new technology achieves low  $R_{DS(on)}$ , energy saving, high reliability and uniformity, superior power density and space saving.

**Absolute Maximum Ratings (  $T_A = 25^\circ C$  unless otherwise specified )**

Symbol	Parameter		Ratings	Unit
<b>Common Ratings</b>				
$V_{DSS}$	Drain-Source Voltage		40	V
$V_{GSS}$			$\pm 20$	
$T_J$	Maximum Junction Temperature		175	$^\circ C$
$T_{STG}$	Storage Temperature Range		-55 to 175	$^\circ C$
$I_S$	Diode Continuous Forward Current	$T_c = 25^\circ C$	380	A
<b>Mounted on Large Heat Sink</b>				
$I_{DM}$	300 $\mu s$ Pulse Drain Current Tested <sup>(2)</sup>	$T_c = 25^\circ C$	1514	A
$I_D$	Continuous Drain Current <sup>(1)</sup>	Silicon Limited	380	A
		Package Limited	192	A
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	397	W

**Thermal Characteristics**

Symbol	Parameter	Ratings	Unit
$R_{thJC}$	Thermal resistance junction-case max <sup>(1)</sup>	0.38	$^\circ C/W$
$R_{thJA}$	Thermal resistance junction-ambient max <sup>(1)</sup>	61	$^\circ C/W$

**Electrical Characteristics** (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>On/off Characteristics</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA	40	--	--	V
I <sub>DS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =32V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	--	--	1	uA
		V <sub>DS</sub> =32V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C	--	--	100	
V <sub>G(S)th</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250uA	1.0		3.0	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
R <sub>D(S)ON</sub>	Drain-SourceOn-stateResistance <sup>(2)</sup>	V <sub>GS</sub> = 10V, I <sub>DS</sub> =80A	--	1.2	1.5	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, Frequency=1MHz	--	8.9	--	nF
C <sub>oss</sub>	Output Capacitance		--	1.5	--	
C <sub>rss</sub>	Reverse Transfer Capacitance		--	0.4	--	
<b>Switching Characteristics</b>						
t <sub>d(ON)</sub>	Turn-on Delay Time	V <sub>DS</sub> =20V, I <sub>D</sub> = 120A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> =2.5 Ω	--	18	--	ns
t <sub>r</sub>	Turn-on Rise Time		--	25	--	
t <sub>d(OFF)</sub>	Turn-off Delay Time		--	133	--	
t <sub>f</sub>	Turn-off Fall Time		--	26	--	
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> = 10V, I <sub>DS</sub> =120A	--	166	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	27	--	
Q <sub>gd</sub>	Gate-Drain Charge		--	39	--	
<b>Avalanche Characteristics</b>						
EAS	Single Pulse Avalanche Energy <sup>(3)</sup>	V <sub>DD</sub> =20V,L=1mH ,V <sub>GS</sub> =10V ,R <sub>g</sub> =25 Ω	648	--	--	mJ
<b>Diode Characteristics</b>						
V <sub>SD</sub>	Diode Forward Voltage <sup>(2)</sup>	I <sub>SD</sub> = 80A, V <sub>GS</sub> = 0	--	--	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> =80A, dI <sub>SD</sub> /dt=100A/μs	--	60	--	ns
q <sub>rr</sub>	Reverse Recovery Charge		--	104	--	nC

## NOTES:

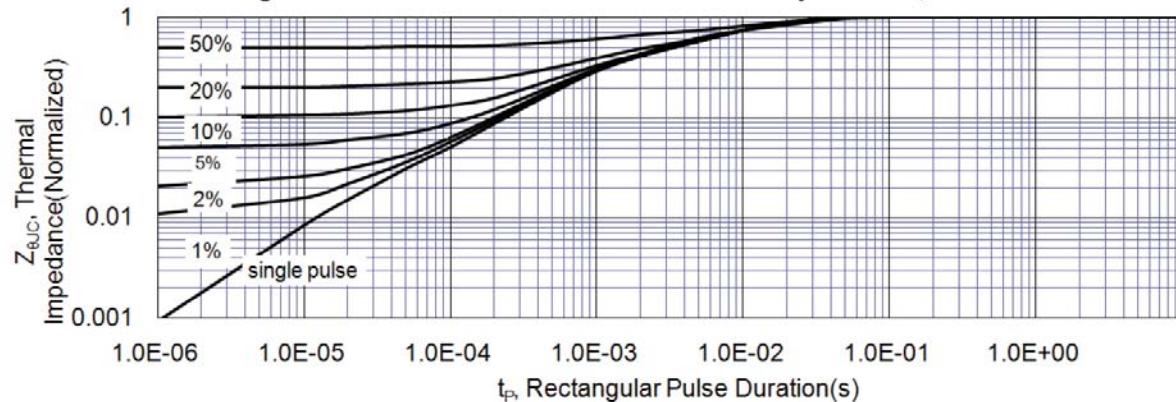
1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%

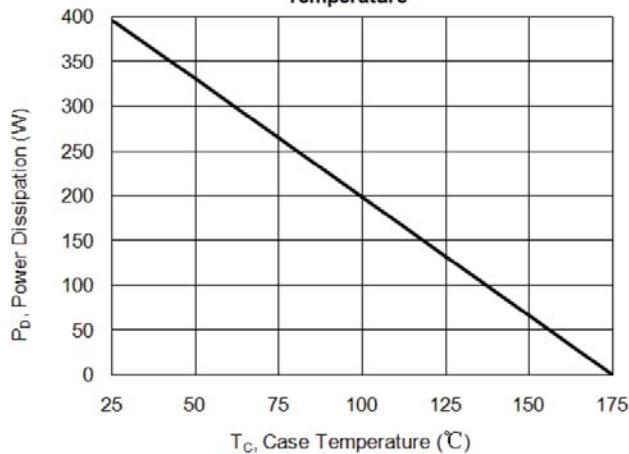
3.The Min. value is 100% EAS tested guarantee.

## Typical Performance Characteristics

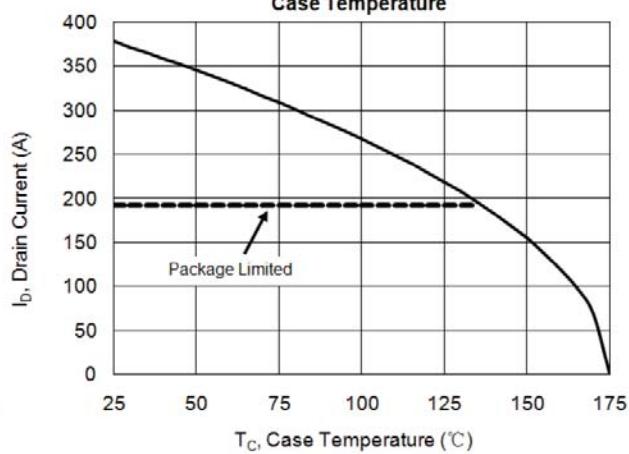
**Figure 1. Maximum Effective Thermal Impedance, Junction-to-Case**



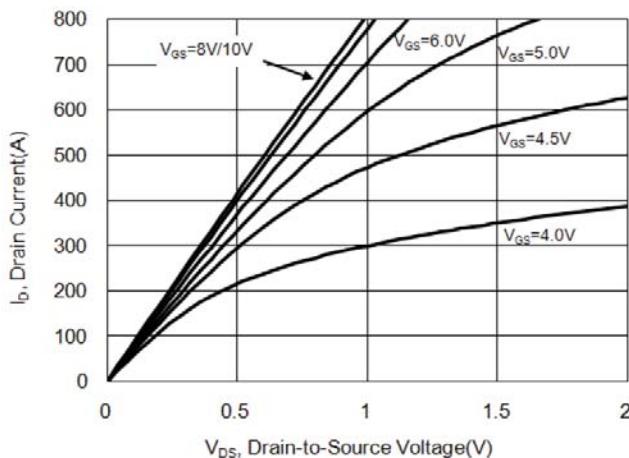
**Figure 2. Maximum Power Dissipation vs. Case Temperature**



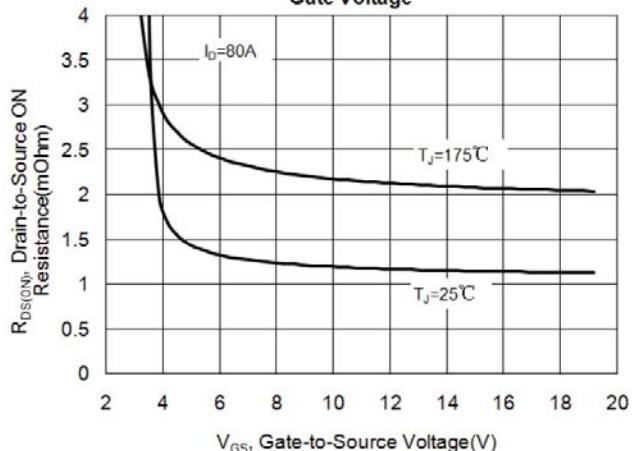
**Figure 3. Maximum Continuous Drain Current vs Case Temperature**

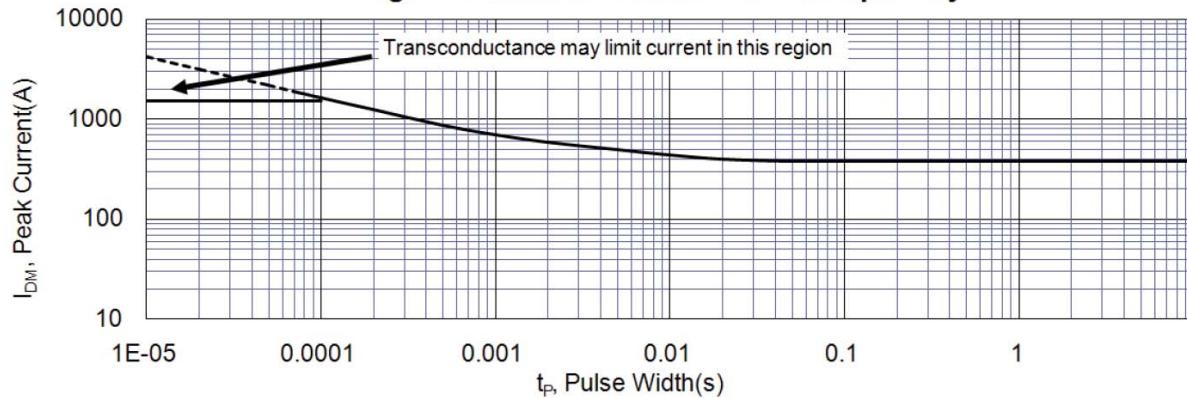
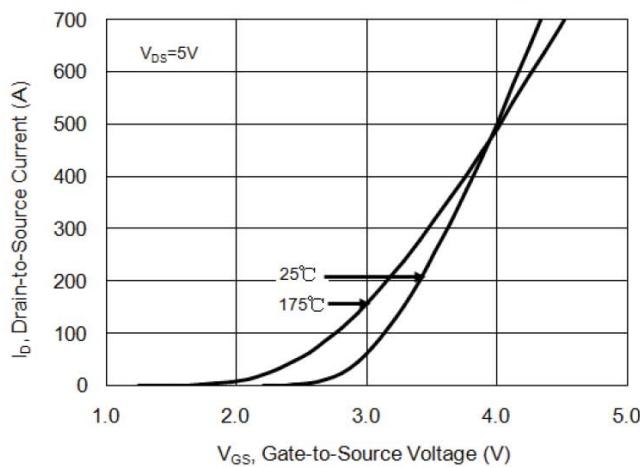
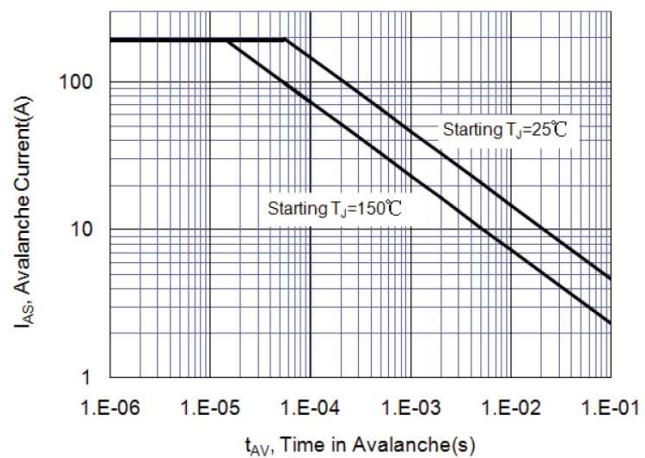
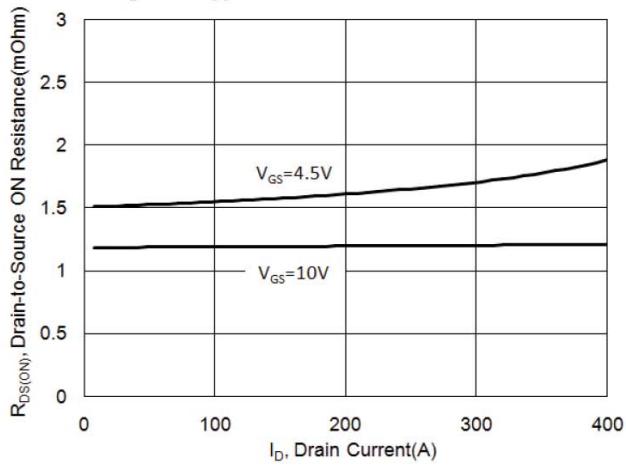
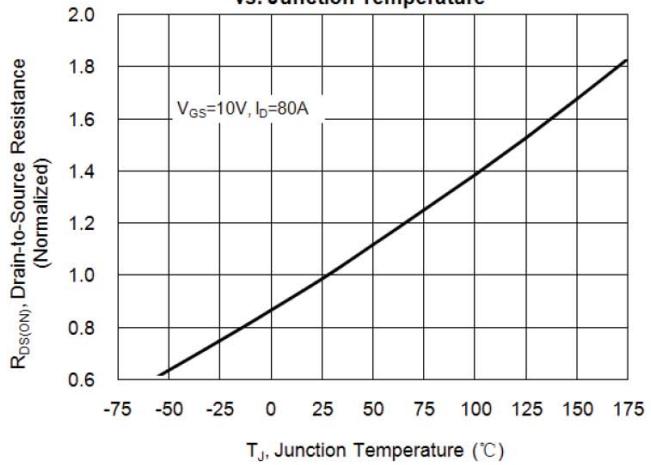


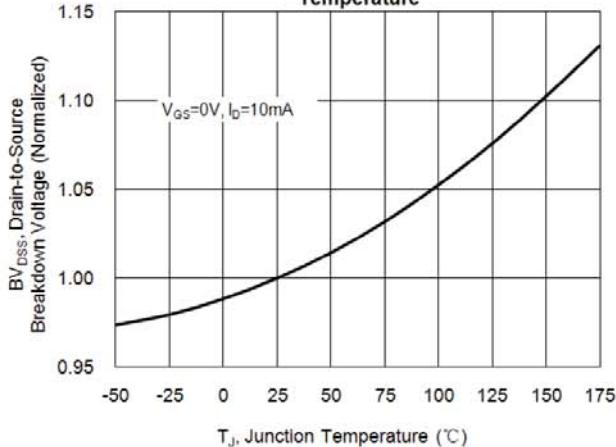
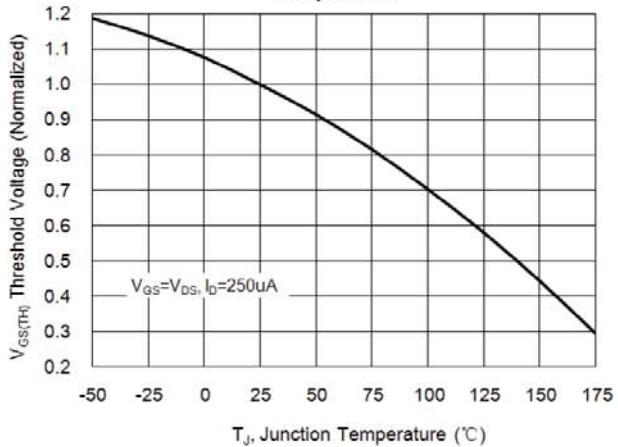
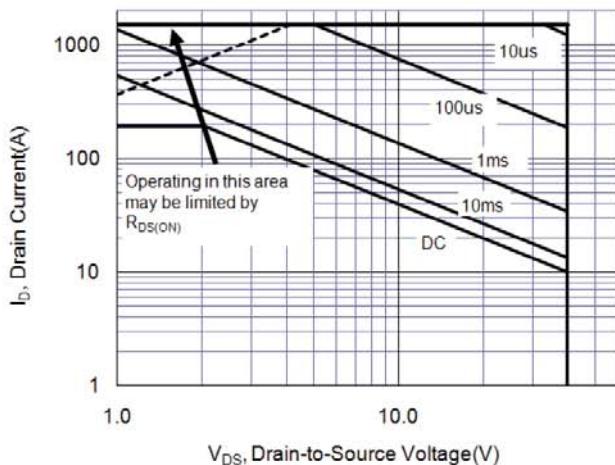
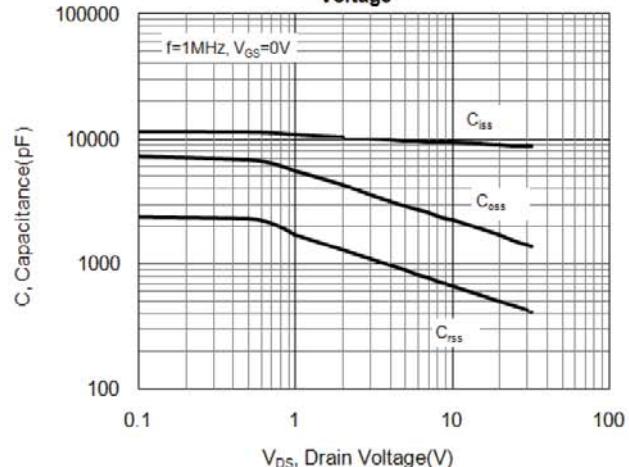
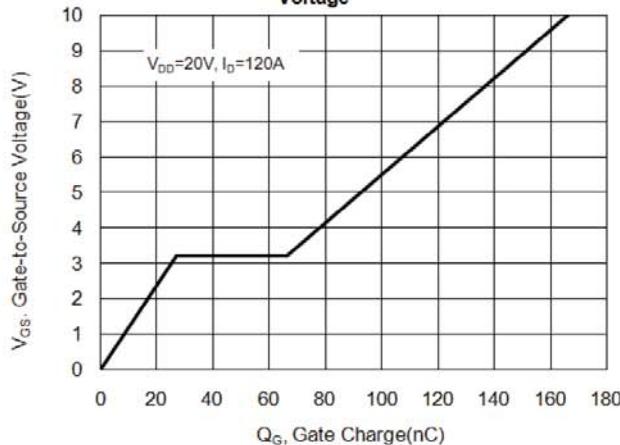
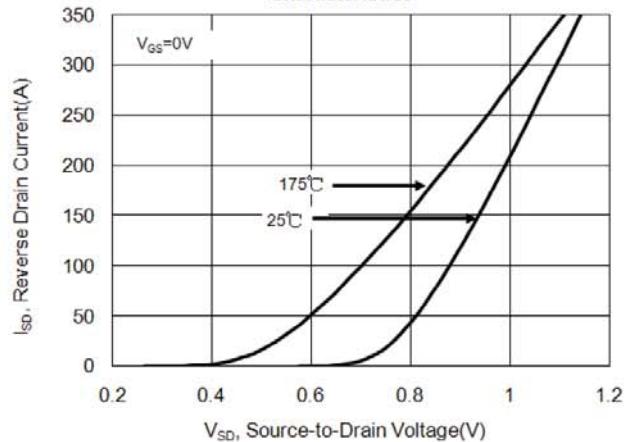
**Figure 4. Typical Output Characteristics**



**Figure 5. Typical Drain-to-Source ON Resistance vs. Gate Voltage**

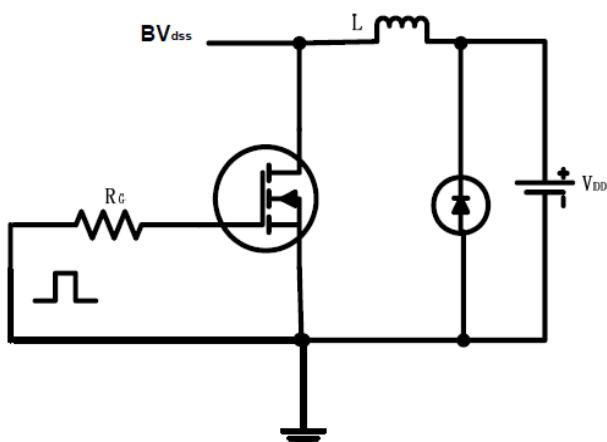


**Figure 6. Maximum Peak Current Capability****Figure 7. Typical Transfer Characteristics****Figure 8. Unclamped Inductive Switching Capability****Figure 9. Typical Drain-to-Source ON Resistance****Figure 10. Typical Drain-to-Source On Resistance vs. Junction Temperature**

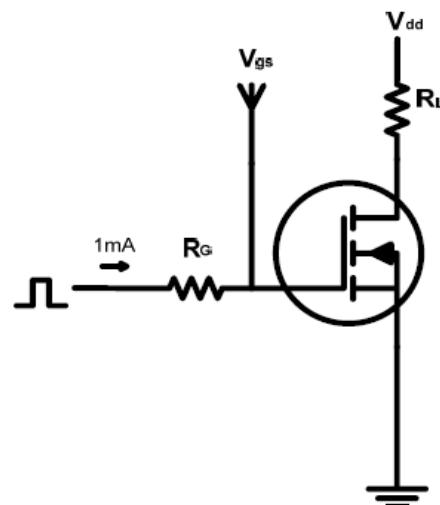
**Figure 11.Typical Breakdown Voltage vs. Junction Temperature****Figure 12.Typical Threshold Voltage vs. Junction Temperature****Figure 13. Maximum Forward Safe Operation Area****Figure 14. Typical Capacitance vs. Drain-to-Source Voltage****Figure 15. Typical Gate Charge vs. Gate-to-Source Voltage****Figure 16. Typical Body Diode Transfer Characteristics**

## Test circuits and Waveforms

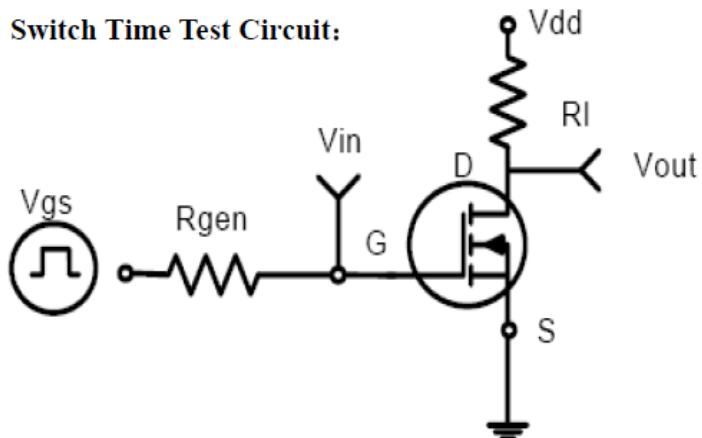
**EAS test circuits:**



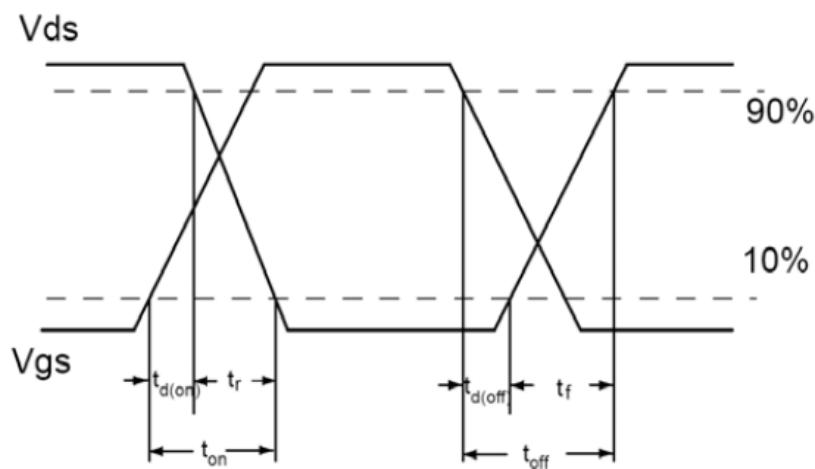
**Gate charge test circuit:**



**Switch Time Test Circuit:**

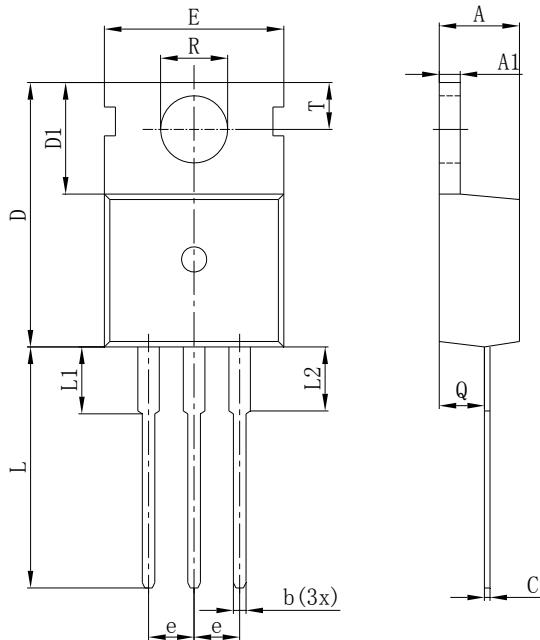


**Switch Waveforms:**



## PACKAGE MECHANICAL DATA

## TO-220C Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
e	2.54 TYP		0.099TYP	
A	4.10	4.70	0.161	0.185
A1	1.25	1.40	0.049	0.055
b	0.60	0.90	0.023	0.035
C	0.40	0.70	0.016	0.027
D	15.20	16.00	0.598	0.630
D1	5.90	6.60	0.232	0.259
E	9.70	10.30	0.382	0.405
L	12.80	15.00	0.504	0.590
L1	2.79	3.30	0.110	0.130
R	3.50	3.80	0.138	0.149
T	2.70	3.00	0.106	0.118
Q	2.20	2.60	0.086	0.102
L2		3.00		0.118

## Ordering information

Part number	Package	Marking	Packing	Quantity
ADM380N04	TO-220C	ADM380N04	Tube	50pcs